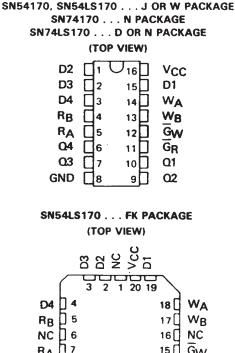
# SN54170, SN54LS170, SN74170, SN74LS170 **4-BY-4 REGISTER FILES WITH OPEN-COLLECTOR OUTPUTS**

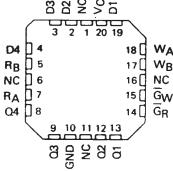
SDLS065 - MARCH 1974 - REVISED MARCH 1988

- Separate Read/Write Addressing Permits Simultaneous Reading and Writing
- Fast Access Times . . . Typically 20 ns
- Organized as 4 Words of 4 Bits
- Expandable to 1024 Words of n-Bits
- For Use as: Scratch-Pad Memory Buffer Storage between Processors Bit Storage in Fast Multiplication Designs
- **Open-Collector Outputs with Low Maximum Off-State Current: 170...30** μA 'LS170 . . . 20 μA
- SN54LS670 and SN74LS670 Are **Similar But Have 3-State Outputs**

## description

The '170 and 'LS170 MSI 16-bit TTL register files incorporate the equivalent of 98 gates. The register file is organized as 4 words of 4 bits each and separate on-chip decoding is provided for addressing the four word locations to either write-in or retrieve data. This permits simultaneous writing into one location and reading from another word location.





NC - No internal connection

Four data inputs are available which are used to supply the 4-bit word to be stored. Location of the word is determined by the write-address inputs A and B in conjunction with a write-enable signal. Data applied at the inputs should be in its true form. That is, if a high-level signal is desired from the output, a high level is applied at the data input for that particular bit location. The latch inputs are arranged so that new data will be accepted only if both internal address gate inputs are high. When this condition exists, data at the D input is transferred to the latch output. When the write-enable input, Gw, is high, the data inputs are inhibited and their levels can cause no change in the information stored in the internal latches. When the read-enable input,  $\overline{G}_{R}$ , is high, the data outputs are inhibited and remain high.

۰.

The individual address lines permit direct acquisition of data stored in any four of the latches. Four individual decoding gates are used to complete the address for reading a word. When the read address is made in conjunction with the read-enable signal, the word appears at the four outputs.

This arrangement-data-entry addressing separate from data-read addressing and individual sense line-eliminates recovery times, permits simultaneous reading and writing, and is limited in speed only by the write time (30 nanoseconds typical) and the read time (25 nanoseconds typical). The register file has a nondestructive readout in that data is not lost when addressed.

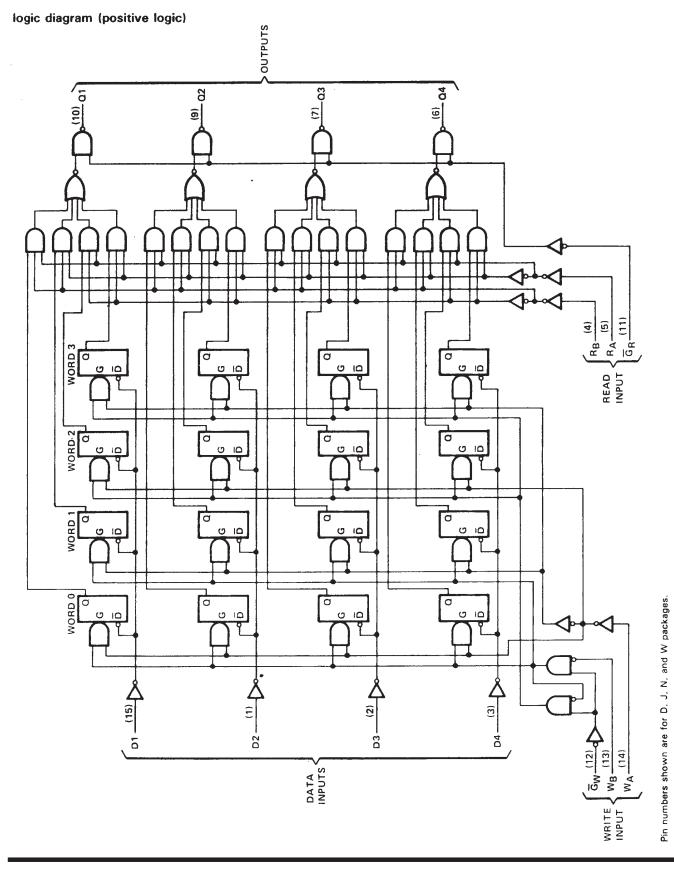
All '170 inputs and all inputs except the read enable and write enable of the 'LS170 are buffered to lower the drive requirements to one Series 54/74 or Series 54LS/74LS standard load, respectively. Input-clamping diodes minimize switching transients to simplify system design. High-speed, double-ended AND-OR-INVERT gates are employed for the read-address function and drive high-sink-current, open-collector outputs. Up to 256 of these outputs may be wire-AND connected for increasing the capacity up to 1024 words. Any number of these registers may be paralleled to provide n-bit word length.

The SN54170 and SN54LS170 are characterized for operation over the full military temperature range of -55°C to 125°C; the SN74170 and SN74LS170 are characterized for operation from 0°C to 70°C.



Copyright © 1988, Texas Instruments Incorporated

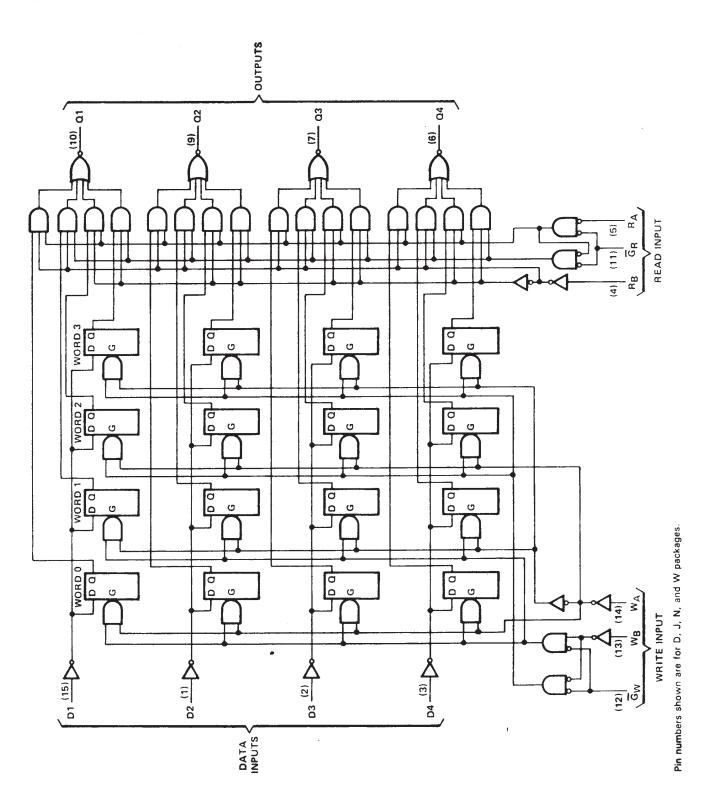
SDLS065 - MARCH 1974 - REVISED MARCH 1988





SDLS065 - MARCH 1974 - REVISED MARCH 1988

logic diagram (positive logic)





# SN54170, SN54LS170, SN74170, SN74LS170 4-BY-4 REGISTER FILES WITH OPEN-COLLECTOR OUTPUTS

## SDLS065 - MARCH 1974 - REVISED MARCH 1988

#### WRITE FUNCTION TABLE (SEE NOTES A, B, AND C)

WR	ITE INP	JTS	WORD					
WB	WA	Ğ₩	0	0 1 2		3		
L	L	L	Q = D	00	00	Q0		
L	н	L	Q0	Q = D	<b>0</b> 0	<b>0</b> 0		
H	Ł	L	Q0	0 <sub>0</sub>	Q = D	a <sub>0</sub>		
H	н	L	0 <sub>0</sub>	<b>Q</b> 0	<b>Q</b> 0	Q = D		
х	х	н	0 <sub>0</sub>	0 <sub>0</sub>	a <sub>0</sub>	Q0		

### READ FUNCTION TABLE (SEE NOTES A AND D)

RE	AD INPL	ITS		OUTPUTS					
RB	RA	GR	Q1	02	Q3	Q4			
L	L	L	WOB1	W0B2	WOB3	WOB4			
L	н	L	W1B1	W182	W183	W1B4			
Н	L	L	W2B1	W2B2	W2B3	W2B4			
н	н	L	W3B1	W3B2	W3B3	W3B4			
х	х	н	н	н	н	н			

NOTES: A. H = high level, L = low level, X = irrelevant.

B. (Q = D) = The four selected internal flip-flop outputs will assume the states applied to the four external data inputs.

C.  $Q_0$  = the level of Q before the indicated input conditions were established.

D. W0B1 = The first bit of word 0, etc.

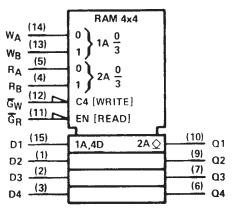
absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V <sub>CC</sub> (see Note 1)	
Input voltage: '170	
· · · · · · · · · · · · · · · · · · ·	
Off-state output voltage: '170	
'LS170	
Operating free-air temperature range: SN54170, SN54LS170 (see Note 2)	
SN74170, SN74LS170	
Storage temperature range	

NOTES: 1. Voltage values are with respect to network ground terminal.

2. An SN54170 in the W package operating at free-air temperatures above 105°C requires a heat sink that provides a thermal resistance from case to free-air, R<sub>ØCA</sub>, of not more than 38°C/W

# logic symbols<sup>†</sup>



<sup>†</sup>This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages,



SDLS065 - MARCH 1974 - REVISED MARCH 1988

## recommended operating conditions

			SN5417	0	SN74170			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>		4.5	5	5.5	4.75	5	5.25	V
High-level output voltage, VOH				5.5			5.5	V
Low-level output current, IOL				16			16	mA
Nidth of write-enable or read-enable pulse, tw		25			25			ns
Setup times, high- or low-level data	Data input with respect to write enable, t <sub>su</sub> ( <u>D</u> )	10			10			ns
(see Figure 2)	Write select with respect to write enable, t <sub>SU</sub> (W)	15			15			ns
Hold times, high- or low-level data (see Note 3 and Figure 2)	Data input with respect to write enable, th(D)	15			15			ns
	Write select with respect to write enable, th(W)	5			5			ns
Latch time for new data, tlatch (see Note 4)		25			25			ns
Operating free-air temperature range, T <sub>A</sub> (see Note 2)		-55		125	0		70	°C

NOTES: 2. An SN54170 in the W package operating at free-air temperatures above 105°C requires a heat sink that provides a thermal resistance from case to free-air, R<sub>BCA</sub>, of not more than 38°C/W.

- 3. Write select setup time will protect the data written into the previous address. If protection of data in the previous address is not required, t<sub>su(W)</sub> can be ignored as any address selection sustained for the final 30 ns of the write-enable pulse and during t<sub>h(W)</sub> will result in data being written into that location. Depending on the duration of the input conditions, one or a number of previous addresses may have been written into.
- 4. Latch time is the time allowed for the internal output of the latch to assume the state of new data. See Figure 2. This is important only when attempting to read from a location immediately after that location has received new data.

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS <sup>†</sup>	MIN	TYP‡	МАХ	UNIT
VIH	High-level input voltage		2			V
VIL	Low-level input voltage				0.8	V
VIK	Input clamp voltage ,	$V_{CC} = MIN, I_I = -12 mA$		-	-1.5	V
tон	High-level output current	V <sub>CC</sub> = MIN, V <sub>OH</sub> = 5.5 V, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = 0.8 V			30	μA
VOL	Low-level output voltage	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = 16 mA		0.2	0.4	V
1	Input current at maximum input voltage	V <sub>CC</sub> = MAX, V <sub>1</sub> = 5.5 V			1	mA
Чн	High-level input current	V <sub>CC</sub> = MAX, V <sub>1</sub> = 2.4 V			40	μA
4	Low-level input current	V <sub>CC</sub> = MAX, V <sub>1</sub> = 0.4 V			-1.6	mA
ICC	Supply current	V <sub>CC</sub> = MAX, SN54170 See Note 5 SN74170		127 §	140 150	mA

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

 $\ensuremath{\$\xspace{1.5}}$  Typical supply current shown is an average for 50% duty cycle.

NOTE 5: Maximum I<sub>CC</sub> is guaranteed for the following worst-case conditions: 4.5 V is applied to all data inputs and both enable inputs, all address inputs are grounded, and all outputs are open.



SDLS065 - MARCH 1974 - REVISED MARCH 1988

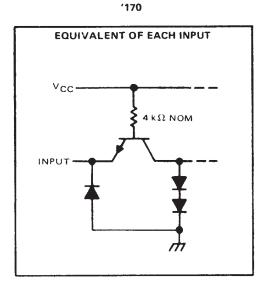
switching characteristics,  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ 

PARAMETER <sup>†</sup>	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	түр	MAX	רואט
tPLH	Deadlocable	A O	C <sub>L</sub> = 15 pF, R <sub>L</sub> = 400 $\Omega$ , See Figures 1 and 2		10	15	ns
tPHL	Read enable	Any Q			20	30	
<sup>t</sup> PLH	Devel Calant	A O			23	35	ns
tPHL	Read Select	Any Q	See Figures 1 and 2		30	40	] ""
tPLH		A 0	C: = 15 = 5	1	25	40	ns
<sup>t</sup> PHL	Write enable	Any Q	CL = 15 pF, RL = 400 Ω, See Figures 1 and 3		34	45	
tPLH	Dette	A 0			20	30	ns
tPHL	Data	Any Q			30	45	1 "

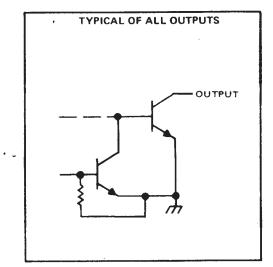
 $t_{PLH}$  = propagation delay time, low-to-high-level output

tpHL = propagation delay time, high-to-low-level output

schematics of inputs and outputs







SDLS065 - MARCH 1974 - REVISED MARCH 1988

# recommended operating conditions

		SN54LS170			SN74LS170			
		MIN	NOM	MAX	MIN	NOM	MAX	UNH
Supply voltage, V <sub>CC</sub>		4.5	5	5.5	4.75	5	5.25	V
High-level output voltage, VOH	tage, V <sub>OH</sub> 5.5			-	5.5	V		
Low-level output current, IOL				4			8	mA
Width of write-enable or read-enable pulse, tw		25			25			ns
Setup times, high- or low-level data	Data input with respect to write enable, t <sub>su(D)</sub>	10			10			ns
(see Figure 2)	Write select with respect to write enable, t <sub>su(W)</sub>	15			15		MAX UN 5.25 \ 5.5 \ 8 m n n n n n	ns
Hold times, high- or low-level data	Data input with respect to write enable, th(D)	15			15		-	ns
(see Note 3 and Figure 2)	Write select with respect to write enable, th(W)	5			5			ns
Latch time for new data, tlatch (see Note 4)	······································	25			25			ns
Operating free-air temperature range, TA		-55		125	0		70	°C

- NOTES: 3. Write-select setup time will protect the data written into the previous address. If protection of data in the previous address is not required, t<sub>su(W)</sub> can be ignored as any address selection sustained for the final 30 ns of the write-enable pulse and during t<sub>h(W)</sub> will result in data being written into that location. Depending on the duration of the input conditions, one or a number of previous addresses may have been written into.
  - 4. Latch time is the time allowed for the internal output of the latch to assume the state of new data. See Figure 2. This is important only when attempting to read from a location immediately after that location has received new data.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		TEOT CON	Durtionet	SN54LS170			SN74LS170			UNIT	
	PARAMETER		TEST CON	TEST CONDITIONS <sup>†</sup>		түр‡	MAX	MIN	TYP‡	MAX	
VIH	High-level input voltage				2	,,		2			V
VIL	Low-level input voltage						0.7			0.8	V
VIK	Input clamp voltage		V <sub>CC</sub> = MIN,	l <sub>1</sub> =18 mA			-1.5			-1.5	V
юн	High-level output current	en e	V <sub>CC</sub> = MIN, V <sub>IL</sub> = V <sub>IL</sub> max.	V <sub>OH</sub> = 5.5 V, , V <sub>IH</sub> = 2 V			100			100	μA
.,			$V_{CC} = MIN,$	I <sub>OL</sub> = 4 mA		0.25	0.4		0.25	0.4	v
VOL	Low-level output voltage		V <sub>IH</sub> = 2 V, V <sub>IL</sub> = V <sub>IL</sub> max	I <sub>OL</sub> = 8 mA					0.35	0.5	
	Input current at	Any D, R, or W		$\lambda = 7 \lambda$			0.1			0.1	mA
1	maximum input voltage		$V_{CC} = MAX,$	V <sub>1</sub> = 7 V			0.2			0.2	
		Any D, R, or W	- MAY	V1 = 2.7 V			20	I		20	μA
1 <sup>†</sup> H	High-level input current	GR or GW	V <sub>CC</sub> = MAX,	vi = 2.7 v			40	1		40	1
		Any D, R, or W		N = 0.4 M			-0.4			-0.4	mA
ΠL	Low-level input current		V <sub>CC</sub> = MAX,	VI = 0.4 V			0.8			-0.8	
Icc	Supply current	• • • • • • • • • •	V <sub>CC</sub> = MAX,	See Note 5		25	40		25	40	mA

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 $All typical values are at V_{CC} = 5 V, T_A = 25^{\circ}C.$ 

NOTE 5: ICC is measured under the following worst-case conditions: 4.5 V is applied to all data inputs and both enable inputs, all address inputs are ground, and all outputs are open.



SDLS065 - MARCH 1974 - REVISED MARCH 1988

# recommended operating conditions

		SI	70	SI	N74LS1	70	UNIT	
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V <sub>CC</sub>		4.5	5	5.5	4.75	5	5.25	V
High-level output voltage, VOH	-			5.5			5.5	V
Low-level output current, IOL				4			8	mA
Width of write-enable or read-enable pulse, tw	· · · · · · · · · · · · · · · · · · ·	25			25			ns
Setup times, high- or low-level data	Data input with respect to write enable, t <sub>su</sub> (D)	10			10			ns
(see Figure 2)	Write select with respect to write enable, t <sub>su(W)</sub>	15			15			ns
Hold times, high- or low-level data	Data input with respect to write enable, th(D)	15			15			ns
(see Note 3 and Figure 2)	Write select with respect to write enable, t <sub>h</sub> (W)	5			5			ns
Latch time for new data, tlatch (see Note 4)		25			25			ns
Operating free-air temperature range, TA		-55		125	0		70	°C

NOTES: 3. Write-select setup time will protect the data written into the previous address. If protection of data in the previous address is not required, t<sub>su(W)</sub> can be ignored as any address selection sustained for the final 30 ns of the write-enable pulse and during t<sub>h(W)</sub> will result in data being written into that location. Depending on the duration of the input conditions, one or a number of previous addresses may have been written into.

4. Latch time is the time allowed for the internal output of the latch to assume the state of new data. See Figure 2. This is important only when attempting to read from a location immediately after that location has received new data.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		TEAT CON	TEAT CONDITIONS		SN54LS170			SN74LS170			
	PARAMETER		TEST CONL	TEST CONDITIONS <sup>†</sup>		MIN TYPT MAX		MIN TYP <sup>‡</sup> MAX			
VIH	High-level input voltage				2			2			V
VIL	Low-level input voltage						0.7			0.8	V
VIK	Input clamp voltage		V <sub>CC</sub> = MIN,	I <sub>1</sub> = -18 mA			-1.5			-1.5	V
ЮН	High-level output current	4	V <sub>CC</sub> = MIN, V <sub>IL</sub> = V <sub>IL</sub> max,	V <sub>OH</sub> = 5.5 V, V <sub>IH</sub> = 2 V			100			100	μA
			$V_{CC} = MIN,$ $V_{IH} = 2 V,$	I <sub>OL</sub> = 4 mA		0.25	0.4		0.25	0.4	
VOL	Low-level output voltage		VIL = VIL max	1 <sub>OL</sub> = 8 mA					0.35	0.5	
	Input current at	Any D, R, or W	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 7 V			0.1			0.1	mA
i (	maximum input voltage	G <sub>R</sub> or G <sub>W</sub>	1 ° CC - MAA,	vi - / v			0.2			0.2	
		Any D, R, or W		V 2 7 V			20			20	μA
ЧΗ	High-level input current	GR or GW	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.7 V			40	Ī		40	1 "
		Any D, R, or W		N - 0 4 M			-0.4			-0.4	mA
ΊL	Low-level input current	GR or GW	$-V_{CC} = MAX,$	V <sub>1</sub> = 0.4 V			0.8			0.8	
1 <sub>CC</sub>	Supply current		V <sub>CC</sub> = MAX,	See Note 5		25	40		25	40	mA

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

**‡**All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

NOTE 5: ICC is measured under the following worst-case conditions: 4.5 V is applied to all data inputs and both enable inputs, all address inputs are ground, and all outputs are open.



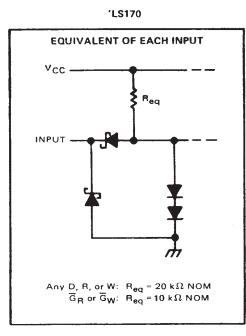
SDLS065 - MARCH 1974 - REVISED MARCH 1988

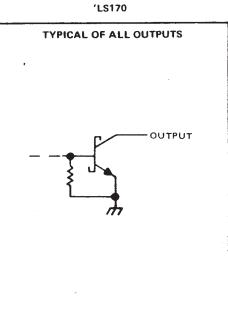
switching characteristics	$, V_{CC} = 5 V, T_{A} = 25^{\circ}C$	
---------------------------	---------------------------------------	--

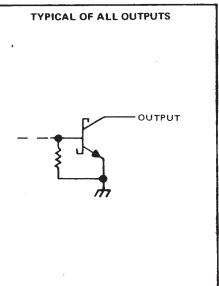
PARAMETER <sup>†</sup> FROM TO (INPUT) (OUTPUT)		TEST CONDITIONS	MIN	ТҮР	MAX	UNIT	
tPLH	Developmenta	A	CL = 15 pF, RL = 2 kΩ, See Figures 1 and 2		20	30	ns
tPHL	Read enable	Any Q			20	30	
<sup>t</sup> PLH	Bar Lasta	A O		2	25	40	ns
tPHL	Read select	Any Q	See Figures 1 and 2		24	40	
ΨLH		A 0	C 15 a5		30	45	ns
tPHL	Write enable	Any Q	CL = 15 pF, RL = 2 kΩ,		26	40	] ""
tPLH	0	A	See Figures 1 and 3		30	45	ns
tPHL	Data	Any Q	See rigures i and S		22	35	-  <sup>ns</sup>

 $^{\dagger}t_{PLH}$  = propagation delay time, low-to-high-level output tPHL = propagation delay time, high-to-low-level output

# schematics of inputs and outputs



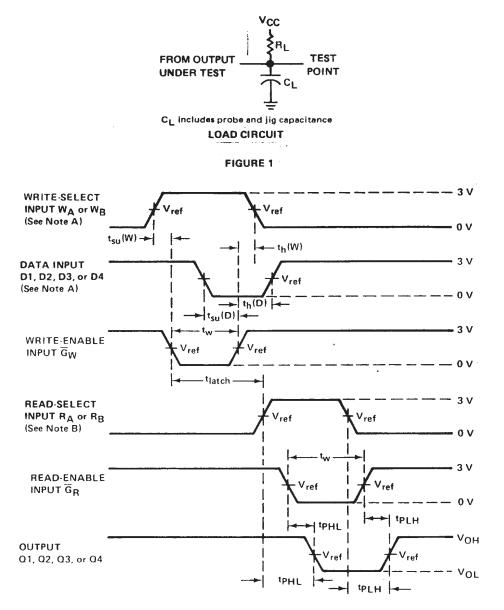






# SN54170, SN54LS170, SN74170, SN74LS170 4-BY-4 REGISTER FILES WITH OPEN-COLLECTOR OUTPUTS

SDLS065 – MARCH 1974 – REVISED MARCH 1988



# PARAMETER MEASUREMENT INFORMATION

#### VOLTAGE WAVEFORMS

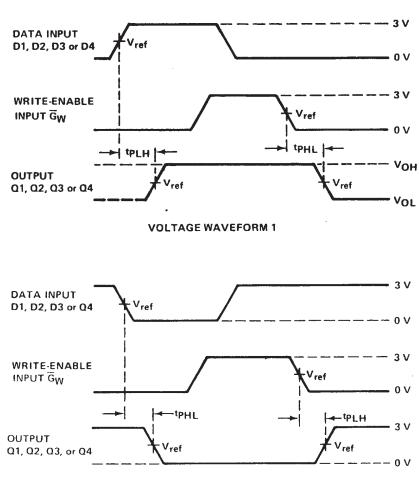
#### FIGURE 2

- NOTES: A. High-level input pulses at the select and data inputs are illustrated in Figure 2; however, times associated with low-level pulses are measured from the same reference points.
  - B. When measuring delay times from a read-select input, the read-enable input is low. When measuring delay times from the read-enable input, both read-select inputs have been established at steady states.
  - C. In Figure 3, each select address is tested. Prior to the start of each of the above tests, both write and read address inputs are stablized with  $W_A = R_A$  and  $W_B = R_B$ . During the test  $G_R$  is low.
  - D. Input waveforms are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>out</sub>  $\approx$  50  $\Omega$ , duty cycle  $\leq$  50%, t<sub>r</sub>  $\leq$  10 ns and t<sub>f</sub>  $\leq$  10 ns for '170, and t<sub>r</sub>  $\leq$  15 ns and t<sub>f</sub>  $\leq$  6 ns for 'LS170.
  - E. For '170,  $V_{ref}$  = 1.5 V; for 'LS170,  $V_{ref}$  = 1.3 V.



# SN54170, SN54LS170, SN74170, SN74LS170 4-BY-4 REGISTER FILES WITH OPEN-COLLECTOR OUTPUTS

SDLS065 - MARCH 1974 - REVISED MARCH 1988



PARAMETER MEASUREMENT INFORMATION .

#### **VOLTAGE WAVEFORM 2**

## FIGURE 3

- NOTES: A. High-level input pulses at the select and data inputs are illustrated in Figure 2; however, times associated with low-level pulses are measured from the same reference points.
  - B. When measuring delay times from a read-select input, the read-enable input is low. When measuring delay times from the read-enable input, both read-select inputs have been established at steady states.
  - C. In Figure 3, each select address is tested. Prior to the start of each of the above tests, both write and read address inputs are stabilized with  $W_A = R_A$  and  $W_B = R_B$ . During the test  $G_R$  is low.
  - D. Input waveforms are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>out</sub>  $\approx$  50  $\Omega$ , duty cycle  $\leq$  50%, t<sub>r</sub>  $\leq$  10 ns and t<sub>f</sub>  $\leq$  10 ns for '170, and t<sub>r</sub> $\leq$  15 ns and t<sub>f</sub>  $\leq$  6 ns for 'LS170.
  - E. For '170,  $V_{ref} = 1.5 V$ ; for 'LS170,  $V_{ref} = 1.3 V$ .



Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
Low Power Wireless	www.ti.com/lpw	Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
Low Power Wireless	www.ti.com/lpw	Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
Low Power Wireless	www.ti.com/lpw	Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
Low Power Wireless	www.ti.com/lpw	Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
Low Power Wireless	www.ti.com/lpw	Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
Low Power Wireless	www.ti.com/lpw	Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
Low Power Wireless	www.ti.com/lpw	Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

# **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
8002501FA	OBSOLETE			16	TBD	Call TI	Call TI
SN54LS170J	OBSOLETE	CDIP	J	16	TBD	Call TI	Call TI
SN54LS170J	OBSOLETE	CDIP	J	16	TBD	Call TI	Call TI
SN74170N	OBSOLETE	PDIP	Ν	16	TBD	Call TI	Call TI
SN74170N	OBSOLETE	PDIP	Ν	16	TBD	Call TI	Call TI
SN74LS170D	OBSOLETE	SOIC	D	16	TBD	Call TI	Call TI
SN74LS170D	OBSOLETE	SOIC	D	16	TBD	Call TI	Call TI
SN74LS170N	OBSOLETE	PDIP	Ν	16	TBD	Call TI	Call TI
SN74LS170N	OBSOLETE	PDIP	Ν	16	TBD	Call TI	Call TI
SNJ54LS170J	OBSOLETE	CDIP	J	16	TBD	Call TI	Call TI
SNJ54LS170J	OBSOLETE	CDIP	J	16	TBD	Call TI	Call TI
SNJ54LS170W	OBSOLETE			16	TBD	Call TI	Call TI
SNJ54LS170W	OBSOLETE			16	TBD	Call TI	Call TI

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

J (R-GDIP-T\*\*) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AC.



Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
RFID	www.ti-rfid.com	Telephony	www.ti.com/telephony
Low Power Wireless	www.ti.com/lpw	Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless



#### ООО "ЛайфЭлектроникс"

ИНН 7805602321 КПП 780501001 Р/С 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 3010181090000000703 БИК 044030703

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный) Email: org@lifeelectronics.ru

# www.lifeelectronics.ru